



## **Highland Copper Announces Further Extension of Loan Maturity Date**

**July 2, 2020 – Longueuil, Quebec.** Highland Copper Company Inc. (TSXV: HI, OTCQB: HDRSF) (the “Company”) announced today that the maturity date for the repayment of outstanding indebtedness under its credit agreement with Greenstone Resources II LP and Osisko Gold Royalties Ltd., of US\$4,500,000 (the “Loan”), was extended to July 31, 2020. Additional information about the Loan can be found in the Company’s press releases issued on May 21, 2019, January 30, 2020 and June 1, 2020, each of which are available on the Company’s website at [www.highlandcopper.com](http://www.highlandcopper.com) and on SEDAR at [www.sedar.com](http://www.sedar.com).

The Company is also in discussion with First Quantum Minerals Ltd. regarding the further extension of the deadline to complete the acquisition of the White Pine North Project. A news release will be issued in due course.

### **About Highland**

Highland Copper Company Inc. is a Canadian company focused on exploring and developing copper projects in the Upper Peninsula of Michigan, U.S.A. More information about the Company is available on the Company’s website at [www.highlandcopper.com](http://www.highlandcopper.com) and on SEDAR at [www.sedar.com](http://www.sedar.com).

*Neither the TSX Venture Exchange nor its Regulation Services Provider (as that term is defined in the policies of the TSX Venture Exchange) accepts responsibility for the adequacy or accuracy of this release.*

For further information, please contact:

Denis Miville-Deschênes, President & CEO

Tel: +1.450.677.2455

Email: [info@highlandcopper.com](mailto:info@highlandcopper.com)